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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s) : SPITZ et al.
Serial No. : To Be Assigned
Filed : Herewith
For : METHOD FOR PRODUCING HEAVILY DOPED
SEMICONDUCTOR COMPONENTS
Art Unit : To Be Assigned
Examiner : To Be Assigned

Assistant Commissioner
for Patents
Washington, D.C. 20231
Box Patent Application

**PRELIMINARY AMENDMENT AND
37 C.F.R. § 1.125 SUBSTITUTE SPECIFICATION STATEMENT**

SIR:

Please amend the above-identified application before examination, as set forth below.

IN THE SPECIFICATION AND ABSTRACT:

In accordance with 37 C.F.R. § 1.121(b)(3), a Substitute Specification (including the Abstract, but without claims) accompanies this response. It is respectfully requested that the Substitute Specification (including Abstract) be entered to replace the Specification of record.

IN THE CLAIMS:

On the first page of the claims, first line, change "What is claimed is:" to:
--What Is Claimed Is--.

Please cancel original claims 1 to 12, without prejudice, and please cancel substitute claim 1, without prejudice, in the underlying PCT Application No. PCT/DE00/00546.

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